

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**Reply under 37 CFR 1.116 – Expedited Procedure**
Examining Group 2822

Application Serial No. 09/536,037
Filing Date March 27, 2000
Inventor Weimin Li et al.
Assignee Micron Technology, Inc.
Group Art Unit..... 2822
Examiner T. Thomas
Attorney's Docket No. MI22-1398
Title: Low k Interlevel Dielectric Lay Fabrication Methods

RESPONSE AFTER NOTICE OF ALLOWANCE AND ISSUE FEE(S) DUE

To: Box AF Amendment
Assistant Commissioner for Patents
Washington, D.C. 20231

From: Bernard Berman (Tel. 509-624-4276; Fax 509-838-3424)
Wells, St. John, Roberts, Gregory & Matkin P.S.
601 W. First Avenue, Suite 1300
Spokane, WA 99201-3828

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Sir:

Responsive to the Notice of Allowance and Issue Fee(s) Due dated December 18, 2001, Applicant remarks as follows.

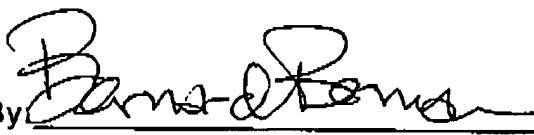
REMARKS

Applicant herewith submits a copy of a Supplemental Information Disclosure Statement and Form PTO-1449 of which it does not yet have an initialed copy from the Examiner. This Information Disclosure Statement was initially submitted to the U.S. Patent and Trademark Office on November 15, 2001. To the extent the PTO-1449 has not already been initialed in the file, such examination and initialing is requested at this time, and returning of a copy to the undersigned.

As this application is in immediate condition for allowance, prompt return
of the initialed 1449 is respectfully requested.

Respectfully submitted,

Dated: Dec 28, 2001

By 
Bernard Berman
Reg. No. 37,279

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